

HEXFRED® Ultrafast Diodes, 300 A (INT-A-PAK Power Modules)



INT-A-PAK

PRIMARY CHARACTERISTICS						
V_R	1200 V					
V _F (typical) at 300 A at 25 °C	2.18 V					
t _{rr} (typical) at 45 A	233 ns					
I _{F(DC)} at T _C	300 A at 60 °C					
Package	INT-A-PAK					
Circuit configuration	Single diode					

FEATURES

· Electrically isolated: DCB base plate

Standard JEDEC® package



- Simplified mechanical designs, rapid assembly
- High surge capability
- Large creepage distances
- Case style INT-A-PAK
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

REMARKS

- Product reliability results valid for $T_J = 150~^{\circ}C$
- Recommended operation temperature T_{op} = 150 °C

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V _R		1200	V	
Continuous forward current		T _C = 25 °C	375	А	
	l _F	T _C = 60 °C	300		
Single pulse forward current	I _{FSM}	T _J = 25 °C	2400		
Maximum power dissipation	PD	T _C = 25 °C	1040	W	
	FD	T _C = 60 °C	750		
RMS isolation voltage	V _{ISOL}	50 Hz, circuit to base, all terminal shorted, t = 1 s	3500	V	
Junction temperature range	TJ		-40 to +150	°C	
Storage temperature range	T _{Stg}		-40 to +150	0	

ELECTRICAL SPECIFICATIONS PER LEG (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	$I_R = 500 \ \mu A$	1200	ı	ı	
Maximum forward voltage	V _{FM}	I _F = 300 A	-	2.18	2.23	V
		I _F = 300 A, T _J = 150 °C	-	2.24	2.47	
Maximum reverse leakage current	I _{RM}	V _R = 1200 V	-	0.06	0.2	mA
		$T_J = 150 ^{\circ}\text{C}, V_R = 1200 \text{V}$	-	ı	20	

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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Diode reverse recovery charge	Q _{rr}	T _J = 25 °C	I _F = 45 A V _R = 400 V dI _F /dt = 500 A/μs	-	3.5	-	μC
		T _J = 125 °C		-	10.4	-	
Reverse recovery time	t _{rr}	T _J = 25 °C		-	233	-	ns
		T _J = 125 °C		-	396	-	
Reverse recovery current	I _{rr}	T _J = 25 °C		-	30	-	A
		T _J = 125 °C		-	53	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum internal thermal resistance, unction to case per leg		DC operation	0.12	°C/W		
Typical thermal resistance, case to heatsink per module	R _{thCS}	Mounting surface flat, smooth, and greased	0.05	C/VV		
Mounting torque ± 10 %	nk	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours	4 to 6	Nm		
busbar	ar	to allow for the spread of the compound	1 20	1411		
Approximate weight			200	g		
			7.1	OZ.		
Case style			INT-A-PAK			

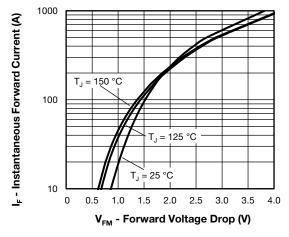


Fig. 1 - Typical Forward Voltage Drop Characteristics

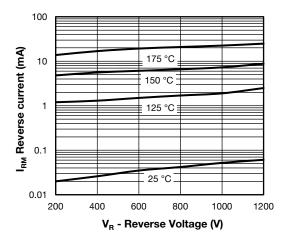


Fig. 2 - Typical Value of Reverse Current vs. Reverse Voltage



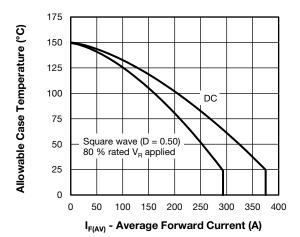


Fig. 3 - Maximum Allowable Case Temperature vs. Average Forward Current

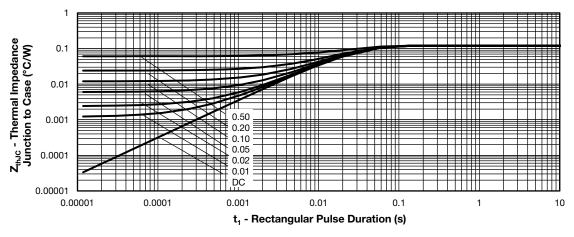


Fig. 4 - Maximum Thermal Impedance R_{thJC} Characteristics

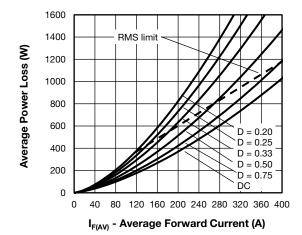


Fig. 5 - Forward Power Loss Characteristics

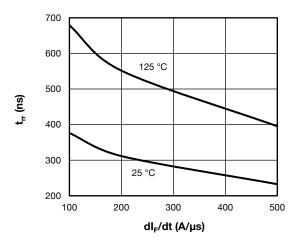
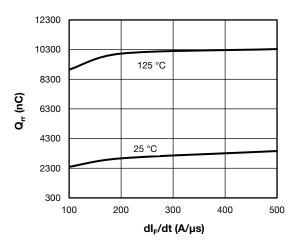


Fig. 6 - Typical Reverse Recovery Time vs. dI_F/dt





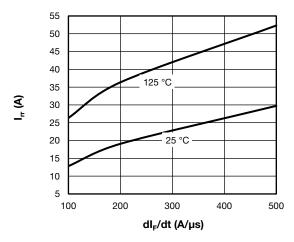
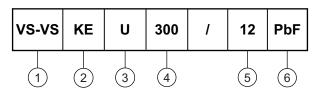


Fig. 8 - Typical Reverse Recovery Current vs. dl_E/dt

ORDERING INFORMATION TABLE

Device code

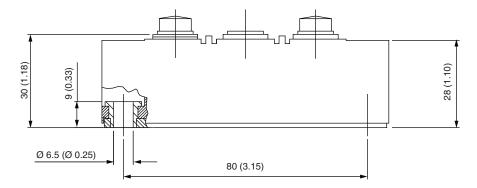


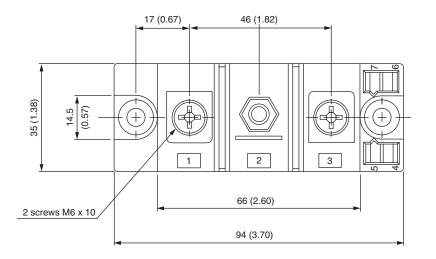
- 1 Vishay Semiconductors product
- 2 KE = circuit configuration
- U = ultrafast diode
- Current rating 300 = 300 A
- 5 Voltage rating (12 = 1200 V)
- 6 PbF = lead (Pb)-free

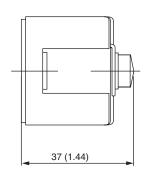
CIRCUIT CONFIGURATION



DIMENSIONS in (inches) millimeters **INT-A-PAK DBC**



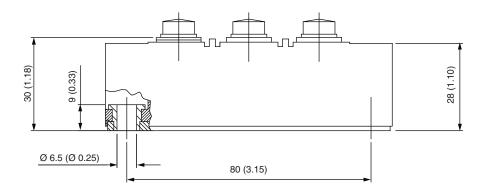


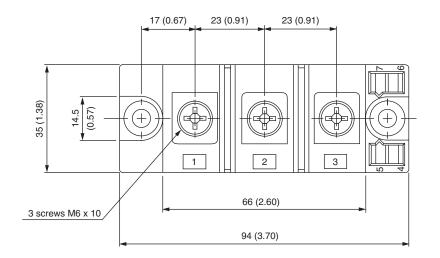


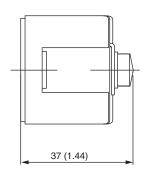


INT-A-PAK DBC

DIMENSIONS in millimeters (inches)







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